

### FEATURES

- Extensional Mode
- Ideal for use with microprocessors
- Designed for low power applications
- Full military testing available
- Low ageing



### DESCRIPTION

CX-1-03 crystals are high quality extensional mode crystals, hermetically sealed in a rugged, ceramic package.

### SPECIFICATION

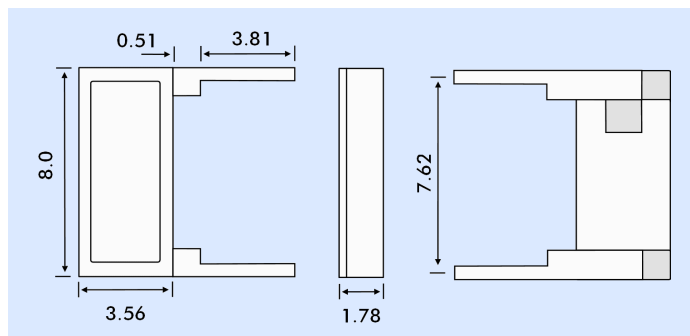
Specifications stated are typical at 25°C unless otherwise indicated. Specifications may change without notice.

Frequency Range:	530kHz to 2.1MHz
Functional Mode:	Extensional
Calibration Tolerance*:	A = ±500ppm (0.05%) B = ±1000ppm (0.1%) C = ±10000ppm (1.0%)
Load Capacitance:	7pF
Motional Resistance:	3kΩ maximum
Motional Capacitance:	1.2fF
Quality Factor:	150k
Drive Level:	3.0μW max.
Turning Point (T <sub>0</sub> )**:	35°C
Temperature Coefficient (k):	-0.035ppm/°C <sup>2</sup>
Note: Frequency f at temperature T is related to frequency F <sub>0</sub> at turning point temperature T <sub>0</sub> by:	$\frac{f-f_0}{f_0} = k(T-T_0)^2$
Ageing, first year:	5ppm max.
Shock, survival:	750g peak, 0.3ms, 1/2 sine
Vibration, survival:	10g rms, 20~1000Hz random
Operating Temperature Range	
Commercial:	-10° to +70°C
Industrial:	-40° to +85°C
Military:	-55 to +125°C
Storage Temperature Range:	-55° to +125°C
Maximum Process Temperature:	See package handling notes.

\* Tighter tolerances are available.

\*\* Other values are available

### OUTLINE & DIMENSIONS



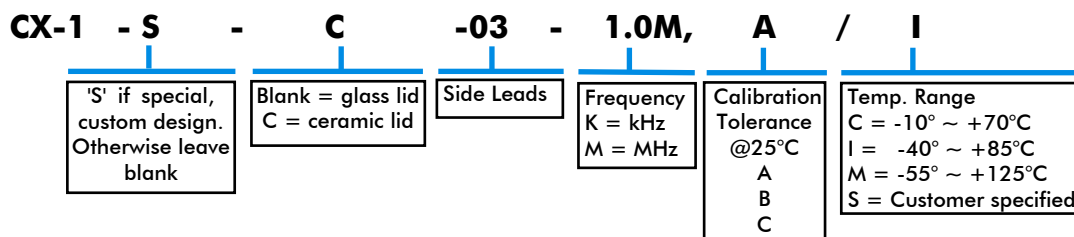
### PACKAGING

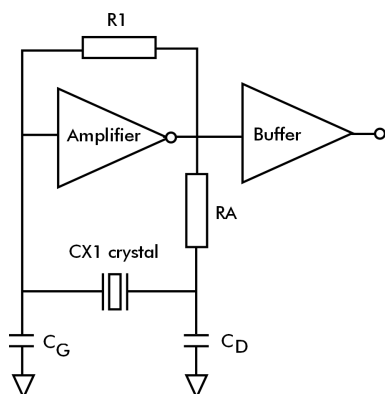
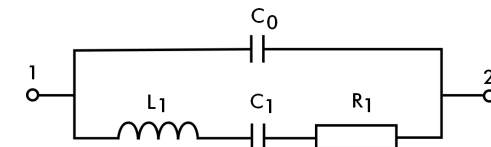
CX-1-03 crystals are Tray Packed as standard.

### PACKAGE HANDLING

The CX crystal is hermetically sealed in a ceramic package. Normal handling and soldering precautions for small, low thermal mass parts are adequate when installing or testing CX crystals. CX crystals may be wave soldered with proper precaution taken to avoid desoldering the leads. A slow machine rate or too high a pre-heat temperature or solder bath temperature may damage the crystals. **Lead to package solder interface temperature should not exceed 175°C, glass lid to package seal rim temperature should not exceed 210°C.** If the seal rim reaches temperatures above the maximum specified, the package may lose its hermeticity. Loss of hermeticity results in a frequency decrease and motional resistance increase.

### HOW TO ORDER CX-1-03 CRYSTALS



**CONVENTIONAL CMOS PIERCE OSCILLATOR CIRCUIT**

**CRYSTAL EQUIVALENT CIRCUIT**


R1 Motional Resistance      L1 Motional Inductance  
C1 Motional Capacitance      C0 Shunt Capacitance

**TYPICAL APPLICATION FOR A PIERCE OSCILLATOR**

The low profile CX miniature crystal is ideal for use in small, high density, battery operated portable products. The CX crystal designed in a Pierce oscillator (single inverter) circuit provides very low current consumption and high stability. A conventional Pierce oscillator is shown above. The crystal is effectively inductive and in a Pi network circuit with  $C_D$  and  $C_G$  provides the additional phase shift to sustain oscillation. The oscillation frequency ( $f_o$ ) is 15 to 250ppm above the crystal's resonant frequency ( $f_s$ ).

**Drive Level**

$R_A$  is used to limit the crystal's drive level by forming a voltage divider between  $R_A$  and  $C_D$ .  $R_A$  also stabilizes the oscillator against changes in the amplifier's output resistance ( $R_o$ ).  $R_A$  should be increased for higher voltage operation.

**Load Capacitance**

The CX crystal calibration tolerance is influenced by the effective circuit capacitances, specified as the load capacitance ( $C_L$ ).  $C_L$  is approximately equal to:

$$C_L = \frac{C_D \times C_G}{C_D + C_G} + C_S$$

Note:  $C_D$  and  $C_G$  include stray layout-induced capacitance to ground and  $C_S$  is the stray shunt capacitance between the crystal terminal. In practice, the effective value of  $C_L$  will be less than that calculated from  $C_D$ ,  $C_G$  and  $C_S$  values because of the effect of the amplifier output resistance.  $C_S$  should be minimized.

The oscillation frequency ( $f_o$ ) is approximately equal to:

$$f_o = f_s \left[ 1 + \frac{C_1}{2(C_0 + C_L)} \right]$$

Where

$f_s$  = Series resonant frequency of the crystal  
 $C_1$  = Motional Capacitance  
 $C_0$  = Shunt Capacitance